

#### AMPMODU | Modu Connector System

TE Internal #: 534972-3

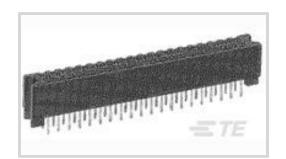
PCB Mount Receptacle, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu

Connector System

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 50

Number of Rows: 2

#### **Features**

#### **Product Type Features**

PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

## **Configuration Features**

Board-to-Board Configuration	Parallel
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	50
Number of Rows	2

#### **Electrical Characteristics**

Operating Voltage	250 VAC
Termination Resistance	12 mΩ
Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 VAC

### **Body Features**

Primary Product Color	Black	
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#### **Contact Features**

PCB Contact Termination Area Plating Material Finish	Bright
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Mating Square Post Dimension	.64 mm[.025 in]
	50 μin
Contact Layout	Inline
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin-Lead
PCB Contact Termination Area Plating Material  Contact Mating Area Plating Material	Tin-Lead Gold (Au)

#### **Termination Features**

Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Post & Tail Length	2.92 mm[.115 in]
Termination Method to PCB	Through Hole - Solder

#### Mechanical Attachment

Mating Retention	Without
Mating Alignment Type	Guide Pin Slots
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	With

## **Housing Features**

Mating Entry Location	Bottom & Top
Housing Material	Philips Ryton
Centerline (Pitch)	2.54 mm[.1 in]

## **Dimensions**

Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	11.43 mm[.45 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]

.238 in



#### **Usage Conditions**

High
-65 – 105 °C[-85 – 221 °F]
Board Standoff
Signal
CSA LR7189, UL E28476

## **Packaging Features**

**UL Flammability Rating** 

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Packaging Method	lube

UL 94V-0

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



## Compatible Parts





# Also in the Series | Modu Connector System



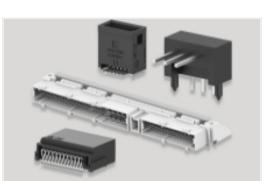
Board-to-Board Headers & Receptacles(814)



Board-to-Board Jumpers & Shunts(5)

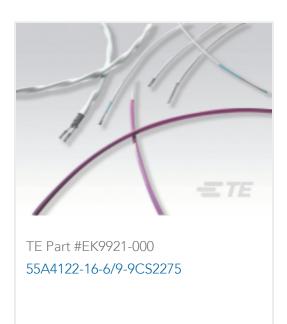


Connector Hardware(4)



PCB Headers & Receptacles(814)

# Customers Also Bought







7724S3664-9









2052 8003 92









### **Documents**

## **Product Drawings**

50 MODII VRT 2PC DR CE 100CL

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_534972-3\_P1.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_534972-3\_P1.3d\_stp.zip

English

**Customer View Model** 

ENG\_CVM\_534972-3\_P1.2d\_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

**Application Specification** 

English

AMPMODU Mod II 2-Piece Double Row Header Assemblies

English